MOTOROLA

SN54/74LS290
SN54/74LS293

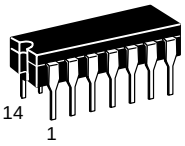
DECADE COUNTER;
4-BIT BINARY COUNTER

The SN54/74LS290 and SN54/74LS293 are high-speed 4-bit ripple type counters partitioned into two sections. Each counter has a divide-by-two section and either a divide-by-five (LS290) or divide-by-eight (LS293) section which are triggered by a HIGH-to-LOW transition on the clock inputs. Each section can be used separately or tied together (Q to CP)to form BCD, Bi-quinary, or Modulo-16 counters. Both of the counters have a 2-input gated Master Reset (Clear), and the LS290 also has a 2-input gated Master Set (Preset 9).

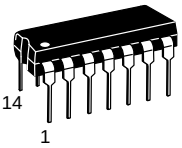
- Corner Power Pin Versions of the LS90 and LS93
- Low Power Consumption . . . Typically 45 mW
- High Count Rates . . . Typically 42 MHz
- Choice of Counting Modes . . . BCD, Bi-Quinary, Binary
- Input Clamp Diodes Limit High Speed Termination Effects

DECADE COUNTER;
4-BIT BINARY COUNTER

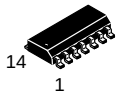
LOW POWER SCHOTTKY



J SUFFIX
CERAMIC
CASE 632-08



N SUFFIX
PLASTIC
CASE 646-06

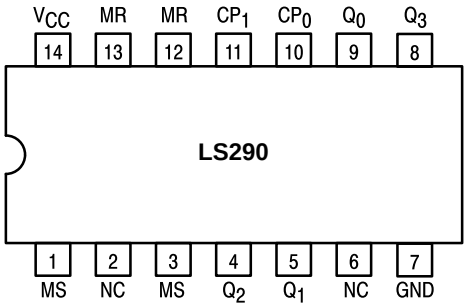


D SUFFIX
SOIC
CASE 751A-02

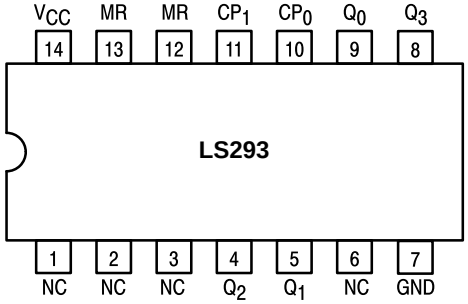
ORDERING INFORMATION

SN54LSXXXJ	Ceramic
SN74LSXXXN	Plastic
SN74LSXXXD	SOIC

CONNECTION DIAGRAM DIP (TOP VIEW)



NOTE:
The Flatpak version has the same pinouts (Connection Diagram) as the Dual In-Line Package.



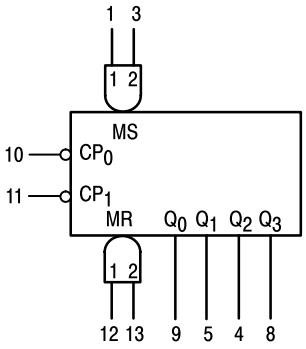
PIN NAMES

		LOADING (Note a) HIGH	LOW
$\overline{CP}_0$	Clock (Active LOW going edge) Input to ÷2 Section.	0.05 U.L.	1.5 U.L.
$\overline{CP}1$	Clock (Active LOW going edge) Input to ÷5 Section (LS290).	0.05 U.L.	2.0 U.L.
CP1	Clock (Active LOW going edge) Input to ÷8 Section (LS293).	0.05 U.L.	1.0 U.L.
MR1, MR2	Master Reset (Clear) Inputs	0.5 U.L.	0.25 U.L.
MS1, MS2	Master Set (Preset-9, LS290) Inputs	0.5 U.L.	0.25 U.L.
Q0	Output from ÷2 Section (Notes b & c)	10 U.L.	5 (2.5) U.L.
Q1, Q2, Q3	Outputs from ÷5 & ÷8 Sections (Note b)	10 U.L.	5 (2.5) U.L.

NOTES:
a) 1 TTL Unit Load (U.L.) = 40 µA HIGH/1.6 mA LOW.
b) The Output LOW drive factor is 2.5 U.L. for Military (54) and 5 U.L. for Commercial (74) Temperature Ranges.
c) The Q_0 Outputs are guaranteed to drive the full fan-out plus the CP_1 Input of the device.

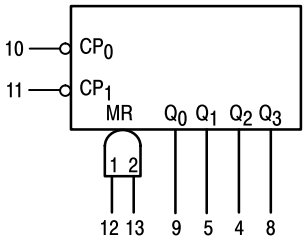
LOGIC SYMBOL

LS290



V_{CC} = PIN 14
GND = PIN 7
NC = PINS 2, 6

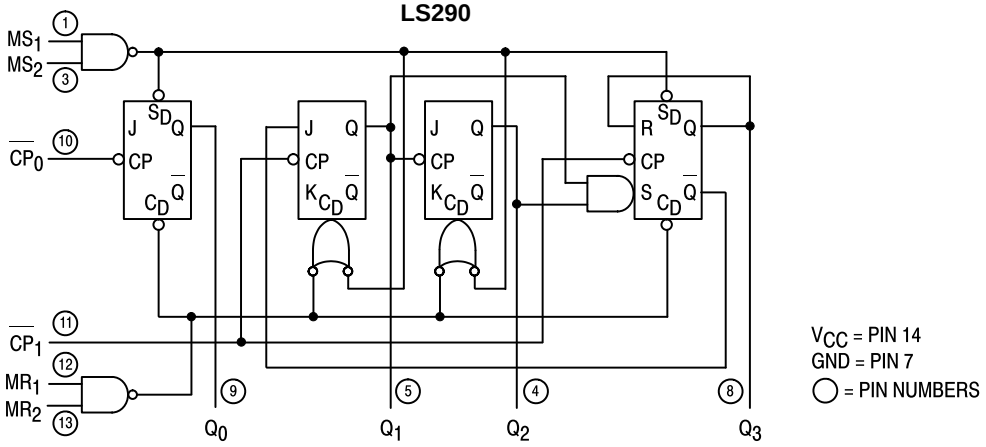
LS293



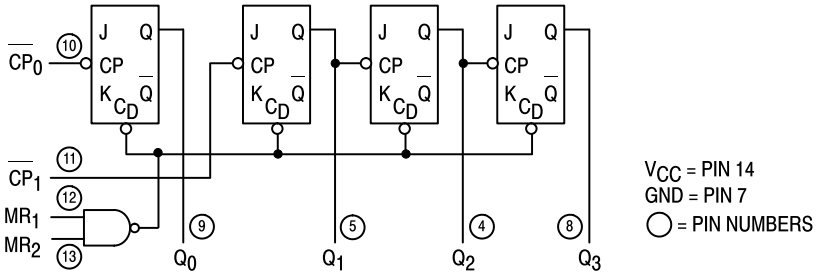
V_{CC} = PIN 14
GND = PIN 7
NC = PINS 1, 2, 3, 6

LOGIC DIAGRAMS

LS290



LS293



FUNCTIONAL DESCRIPTION

The LS290 and LS293 are 4-bit ripple type Decade, and 4-Bit Binary counters respectively. Each device consists of four master/slave flip-flops which are internally connected to provide a divide-by-two section and a divide-by-five (LS290) or divide-by-eight (LS293) section. Each section has a separate clock input which initiates state changes of the counter on the HIGH-to-LOW clock transition. State changes of the Q outputs do not occur simultaneously because of internal ripple delays. Therefore, decoded output signals are subject to decoding spikes and should not be used for clocks or strobes. The Q_0 output of each device is designed and specified to drive the rated fan-out plus the CP_1 input of the device.

A gated AND asynchronous Master Reset ($MR_1 \cdot MR_2$) is provided on both counters which overrides the clocks and resets (clears) all the flip-flops. A gated AND asynchronous Master Set ($MS_1 \cdot MS_2$) is provided on the LS290 which overrides the clocks and the MR inputs and sets the outputs to nine (HLLH).

Since the output from the divide-by-two section is not internally connected to the succeeding stages, the devices may be operated in various counting modes:

LS290

A. BCD Decade (8421) Counter — the $\overline{CP}_1$ input must be externally connected to the Q_0 output. The $\overline{CP}_0$ input receives the incoming count and a BCD count sequence is produced.

B. Symmetrical Bi-quinary Divide-By-Ten Counter — The Q_3 output must be externally connected to the CP_0 input. The input count is then applied to the CP_1 input and a divide-by-ten square wave is obtained at output Q_0.

C. Divide-By-Two and Divide-By-Five Counter — No external interconnections are required. The first flip-flop is used as a binary element for the divide-by-two function (CP_0 as the input and Q_0 as the output). The CP_1 input is used to obtain binary divide-by-five operation at the Q_3 output.

LS293

A. 4-Bit Ripple Counter — The output Q_0 must be externally connected to input CP_1. The input count pulses are applied to input CP_0. Simultaneous division of 2, 4, 8, and 16 are performed at the Q_0, Q_1, Q_2, and Q_3 outputs as shown in the truth table.

B. 3-Bit Ripple Counter — The input count pulses are applied to input CP_1. Simultaneous frequency divisions of 2, 4, and 8 are available at the Q_1, Q_2, and Q_3 outputs. Independent use of the first flip-flop is available if the reset function coincides with reset of the 3-bit ripple-through counter.

LS290 MODE SELECTION

RESET/SET INPUTS				OUTPUTS			
MR_1	MR_2	MS_1	MS_2	Q_0	Q_1	Q_2	Q_3
H	H	L	X	L	L	L	L
H	H	X	L	L	L	L	L
X	X	H	H	H	L	L	H
L	X	L	X	Count			
X	L	X	L	Count			
L	X	X	L	Count			
X	L	L	X	Count			

LS290
BCD COUNT SEQUENCE

COUNT	OUTPUT			
	Q_0	Q_1	Q_2	Q_3
0	L	L	L	L
1	H	L	L	L
2	L	H	L	L
3	H	H	L	L
4	L	L	H	L
5	H	L	H	L
6	L	H	H	L
7	H	H	H	L
8	L	L	L	H
9	H	L	L	H

NOTE: Output Q_0 is connected to Input CP_1 for BCD count.

H = HIGH Voltage Level
L = LOW Voltage Level
X = Don't Care

LS293 MODE SELECTION

RESET INPUTS		OUTPUTS			
MR_1	MR_2	Q_0	Q_1	Q_2	Q_3
H	H	L	L	L	L
L	H	Count			
H	L	Count			
L	L	Count			

TRUTH TABLE

COUNT	OUTPUT			
	Q_0	Q_1	Q_2	Q_3
0	L	L	L	L
1	H	L	L	L
2	L	H	L	L
3	H	H	L	L
4	L	L	H	L
5	H	L	H	L
6	L	H	H	L
7	H	H	H	L
8	L	L	L	H
9	H	L	L	H
10	L	H	L	H
11	H	H	L	H
12	L	L	H	H
13	H	L	H	H
14	L	H	H	H
15	H	H	H	H

Note: Output Q_0 connected to input CP_1.

GUARANTEED OPERATING RANGES

Symbol	Parameter		Min	Typ	Max	Unit
V_{CC}	Supply Voltage	54 74	4.5 4.75	5.0 5.0	5.5 5.25	V
T_A	Operating Ambient Temperature Range	54 74	–55 0	25 25	125 70	°C
I_{OH}	Output Current — High	54, 74			–0.4	mA
I_{OL}	Output Current — Low	54 74			4.0 8.0	mA

DC CHARACTERISTICS OVER OPERATING TEMPERATURE RANGE (unless otherwise specified)

Symbol	Parameter		Limits Min	Limits Typ	Limits Max	Unit	Test Conditions	
V_{IH}	Input HIGH Voltage		2.0			V	Guaranteed Input HIGH Voltage for All Inputs	
V_{IL}	Input LOW Voltage	54			0.7	V	Guaranteed Input LOW Voltage for All Inputs	
		74			0.8			
V_{IK}	Input Clamp Diode Voltage			–0.65	–1.5	V	V_{CC} = MIN, I_{IN} = –18 mA	
V_{OH}	Output HIGH Voltage	54	2.5	3.5		V	V_{CC} = MIN, I_{OH} = MAX, V_{IN} = V_{IH} or V_{IL} per Truth Table	
		74	2.7	3.5		V		
V_{OL}	Output LOW Voltage	54, 74		0.25	0.4	V	I_{OL} = 4.0 mA	V_{CC} = V_{CC} MIN, V_{IN} = V_{IL} or V_{IH} per Truth Table
		74		0.35	0.5	V	I_{OL} = 8.0 mA	
I_{IH}	Input HIGH Current				20	µA	V_{CC} = MAX, V_{IN} = 2.7 V	
					0.1	mA	V_{CC} = MAX, V_{IN} = 7.0 V	
I_{IL}	Input LOW Current $\overline{MS}$, MR $\overline{CP_0}$ $\overline{CP_1}$ (LS290) CP_1 (LS293)				–0.4 –2.4 –3.2 –1.6	mA	V_{CC} = MAX, V_{IN} = 0.4 V	
I_{OS}	Short Circuit Current (Note 1)		–20		–100	mA	V_{CC} = MAX	
I_{CC}	Power Supply Current				15	mA	V_{CC} = MAX	

Note 1: Not more than one output should be shorted at a time, nor for more than 1 second.

AC CHARACTERISTICS (T_A = 25°C, V_{CC} = 5.0 V, C_L = 15 pF)

Symbol	Parameter	Limits						Unit
		LS290			LS293			
		Min	Typ	Max	Min	Typ	Max	
f_{MAX}	$\overline{CP}_0$ Input Clock Frequency	32			32			MHz
f_{MAX}	$\overline{CP}_1$ Input Clock Frequency	16			16			MHz
t_{PLH} t_{PHL}	Propagation Delay, $\overline{CP}_0$ Input to Q_0 Output		10 12	16 18		10 12	16 18	ns
t_{PLH} t_{PHL}	$\overline{CP}_0$ Input to Q_3 Output		32 34	48 50		46 46	70 70	ns
t_{PLH} t_{PHL}	$\overline{CP}_1$ Input to Q_1 Output		10 14	16 21		10 14	16 21	ns
t_{PLH} t_{PHL}	$\overline{CP}_1$ Input to Q_2 Output		21 23	32 35		21 23	32 35	ns
t_{PLH} t_{PHL}	$\overline{CP}_1$ Input to Q_3 Output		21 23	32 35		34 34	51 51	ns
t_{PHL}	MS Input to Q_0 and Q_3 Outputs		20	30				ns
t_{PHL}	MS Input to Q_1 and Q_2 Outputs		26	40				ns
t_{PHL}	MR Input to Any Output		26	40		26	40	ns

AC SETUP REQUIREMENTS (T_A = 25°C, V_{CC} = 5.0 V)

Symbol	Parameter	Limits				Unit
		LS290		LS293		
		Min	Max	Min	Max	
t_W	$\overline{CP}_0$ Pulse Width	15		15		ns
t_W	$\overline{CP}_1$ Pulse Width	30		30		ns
t_W	MS Pulse Width	15				ns
t_W	MR Pulse Width	15		15		ns
t_{rec}	Recovery Time MR to $\overline{CP}$	25		25		ns

RECOVERY TIME (t_{rec}) is defined as the minimum time required between the end of the reset pulse and the clock transition form HIGH-to-LOW in order to recognize and transfer HIGH data to the Q outputs.

AC WAVEFORMS

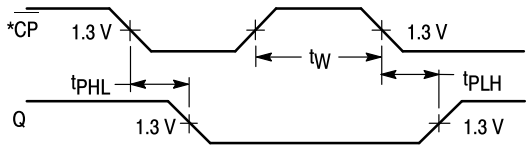


Figure 1

*The number of Clock Pulses required between the t_{PHL} and t_{PLH} measurements can be determined from the appropriate Truth Tables.

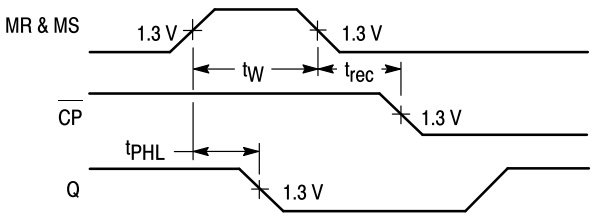


Figure 2

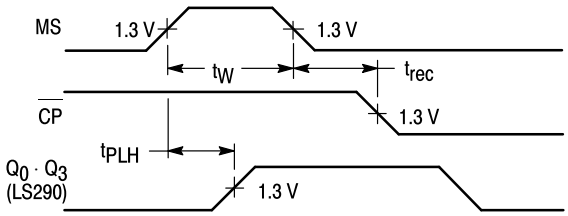
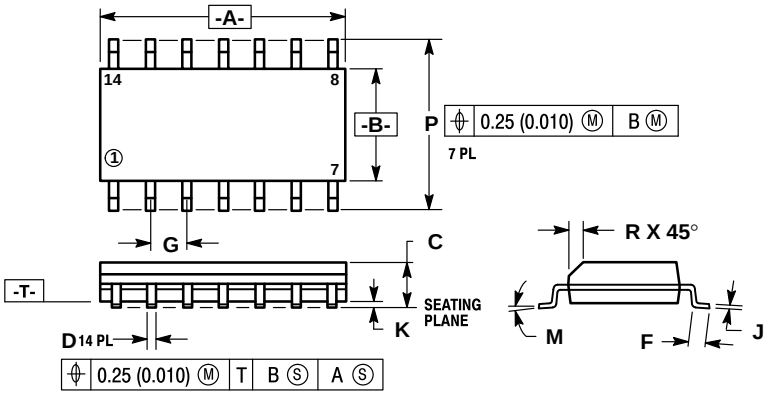


Figure 3

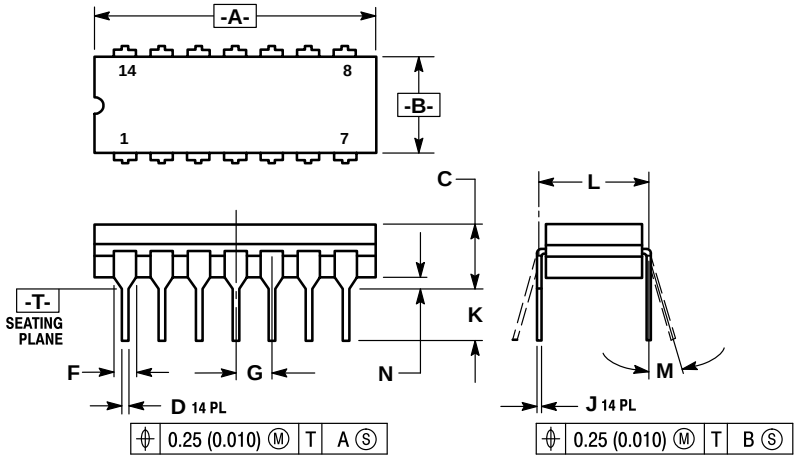
Case 751A-02 D Suffix
14-Pin Plastic
SO-14



NOTES:
1. DIMENSIONS "A" AND "B" ARE DATUMS AND "T" IS A DATUM SURFACE.
2. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
3. CONTROLLING DIMENSION: MILLIMETER.
4. DIMENSION A AND B DO NOT INCLUDE MOLD PROTRUSION.
5. MAXIMUM MOLD PROTRUSION 0.15 (0.006) PER SIDE.
6. 751A-01 IS OBSOLETE, NEW STANDARD 751A-02.

	MILLIMETERS		INCHES	
DIM	MIN	MAX	MIN	MAX
A	8.55	8.75	0.337	0.344
B	3.80	4.00	0.150	0.157
C	1.35	1.75	0.054	0.068
D	0.35	0.49	0.014	0.019
F	0.40	1.25	0.016	0.049
G	1.27 BSC		0.050 BSC	
J	0.19	0.25	0.008	0.009
K	0.10	0.25	0.004	0.009
M	0°	7°	0°	7°
P	5.80	6.20	0.229	0.244
R	0.25	0.50	0.010	0.019

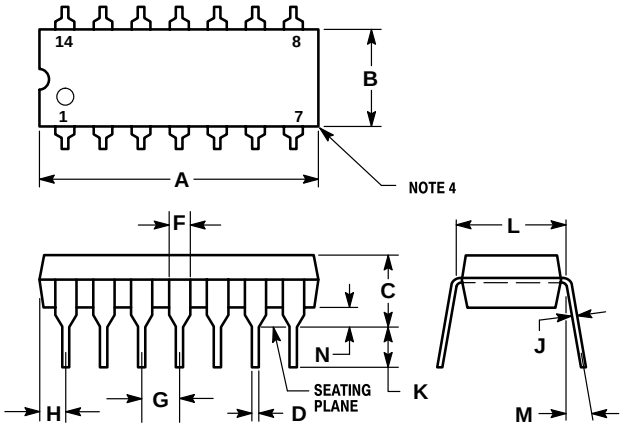
Case 632-08 J Suffix
14-Pin Ceramic Dual In-Line



NOTES:
1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: INCH.
3. DIMENSION L TO CENTER OF LEAD WHEN FORMED PARALLEL.
4. DIM F MAY NARROW TO 0.76 (0.030) WHERE THE LEAD ENTERS THE CERAMIC BODY.
5. 632-01 THRU -07 OBSOLETE, NEW STANDARD 632-08.

	MILLIMETERS		INCHES	
DIM	MIN	MAX	MIN	MAX
A	19.05	19.94	0.750	0.785
B	6.23	7.11	0.245	0.280
C	3.94	5.08	0.155	0.200
D	0.39	0.50	0.015	0.020
F	1.40	1.65	0.055	0.065
G	2.54 BSC		0.100 BSC	
J	0.21	0.38	0.008	0.015
K	3.18	4.31	0.125	0.170
L	7.62 BSC		0.300 BSC	
M	0°	15°	0°	15°
N	0.51	1.01	0.020	0.040

Case 646-06 N Suffix
14-Pin Plastic



NOTES:
1. LEADS WITHIN 0.13 mm (0.005) RADIUS OF TRUE POSITION AT SEATING PLANE AT MAXIMUM MATERIAL CONDITION.
2. DIMENSION "L" TO CENTER OF LEADS WHEN FORMED PARALLEL.
3. DIMENSION "B" DOES NOT INCLUDE MOLD FLASH.
4. ROUNDED CORNERS OPTIONAL.
5. 646-05 OBSOLETE, NEW STANDARD 646-06.

	MILLIMETERS		INCHES	
DIM	MIN	MAX	MIN	MAX
A	18.16	19.56	0.715	0.770
B	6.10	6.60	0.240	0.260
C	3.69	4.69	0.145	0.185
D	0.38	0.53	0.015	0.021
F	1.02	1.78	0.040	0.070
G	2.54 BSC		0.100 BSC	
H	1.32	2.41	0.052	0.095
J	0.20	0.38	0.008	0.015
K	2.92	3.43	0.115	0.135
L	7.62 BSC		0.300 BSC	
M	0°	10°	0°	10°
N	0.39	1.01	0.015	0.039

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